

Regulated, 125mA-Output, Charge-Pump DC-DC Inverter

ABSOLUTE MAXIMUM RATINGS

IN	-0.3V to +6V	Continuous Power Dissipation ($T_A = +70^\circ\text{C}$)	
CAP+, FB, LIN/SKIP	-0.3V to ($V_{IN} + 0.3\text{V}$)	(derate 5.88mW/ $^\circ\text{C}$ above $+70^\circ\text{C}$)	450mW
SHDN	-0.3V to +6V	Operating Temperature Range	-40°C to $+85^\circ\text{C}$
OUT, CAP-	-6V to +0.3V	Junction Temperature	$+150^\circ\text{C}$
Continuous Output Current	135mA	Storage Temperature Range	-65°C to $+160^\circ\text{C}$
Output Short-Circuit Duration to GND (Note 1)	1sec	Lead Temperature (soldering, 10sec)	$+300^\circ\text{C}$

Note 1: Shorting OUT to IN may damage the device and should be avoided.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

($V_{IN} = V_{SHDN} = +5\text{V}$, $C_{IN} = 10\mu\text{F}$, $C_{OUT} = 22\mu\text{F}$, $C_{FLY} = 2.2\mu\text{F}$, $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$, unless otherwise noted. Typical values are at $T_A = +25^\circ\text{C}$.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input Voltage Range	V_{IN}	LIN/SKIP = GND (Skip mode)	2.0		5.5	V
		LIN/SKIP = IN (LIN mode)	2.7		5.5	
Minimum Output Voltage	V_{OUT}	LIN/SKIP = GND		0		V
		LIN/SKIP = IN	-1.5			
Maximum Output Current	$I_{OUT(MAX)}$		125			mA
Output Voltage	V_{OUT}	R1 = 100k Ω , $\pm 1\%$, R2 = 60.4k Ω , $\pm 1\%$, $I_{OUT} = 0\text{mA}$ to 125mA, Figure 1 LIN/SKIP = IN (LIN mode)	-2.90	-3.02	-3.15	V
		LIN/SKIP = GND (Skip mode)	-2.92	-3.02	-3.12	
Quiescent Current (I_{IN} Current)	I_Q	$V_{FB} = -100\text{mV}$, $V_{OUT} = -3\text{V}$, LIN/SKIP = IN (LIN mode)		8	16	mA
		$V_{FB} = -25\text{mV}$, $V_{OUT} = -3\text{V}$, LIN/SKIP = GND (Skip mode)		0.035	0.2	
Shutdown Current (I_{IN} Current)	I_{SHDN}	SHDN = GND		0.1	1	μA
Line Regulation	ΔV_{LNR}	$V_{IN} = 4.5\text{V}$ to 5.5V , Figure 4, $V_{REF} \neq V_{IN}$ LIN/SKIP = IN (LIN mode)		0.01		%/V
		LIN/SKIP = GND (Skip mode)		1		
Load Regulation	ΔV_{LDR}	$I_{OUT} = 25\text{mA}$ to 125mA, Figure 1 LIN/SKIP = IN (LIN mode)		0.01		%/mA
		LIN/SKIP = GND (Skip mode)		0.005		
Open-Loop Output Resistance (Dropout)	R_O	LIN/SKIP = GND (Skip mode)		3.5	10	Ω
Output Resistance to Ground in Shutdown Mode		SHDN = GND		1	5	Ω

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ELECTRICAL CHARACTERISTICS (continued)

($V_{IN} = V_{SHDN} = +5V$, $C_{IN} = 10\mu F$, $C_{OUT} = 22\mu F$, $C_{FLY} = 2.2\mu F$, $T_A = -40^\circ C$ to $+85^\circ C$, unless otherwise noted. Typical values are at $T_A = +25^\circ C$.) (Note 2)

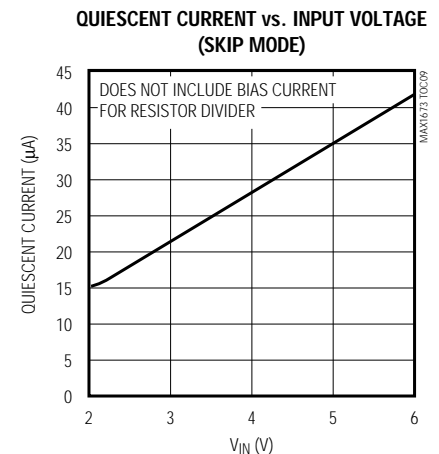
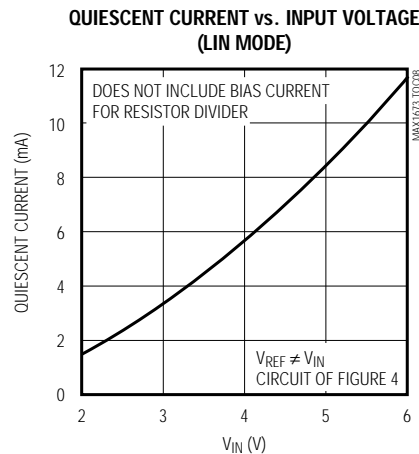
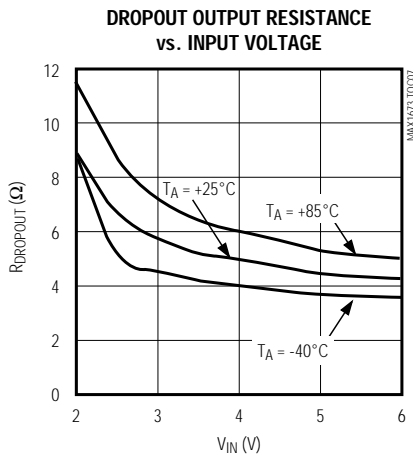
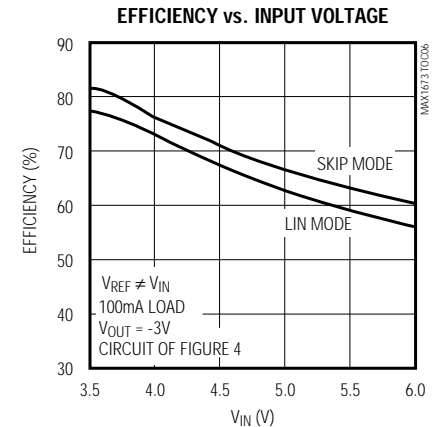
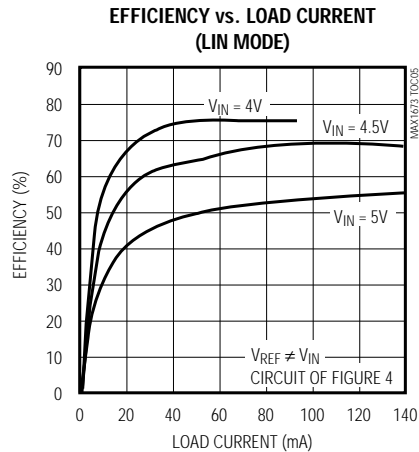
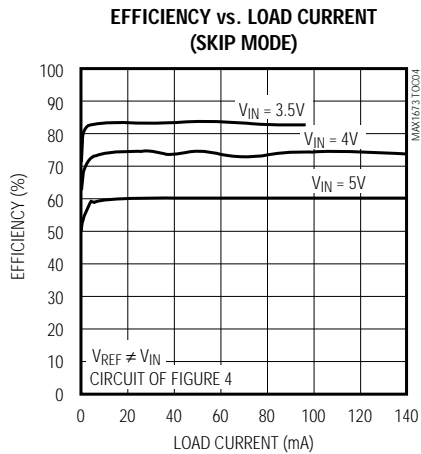
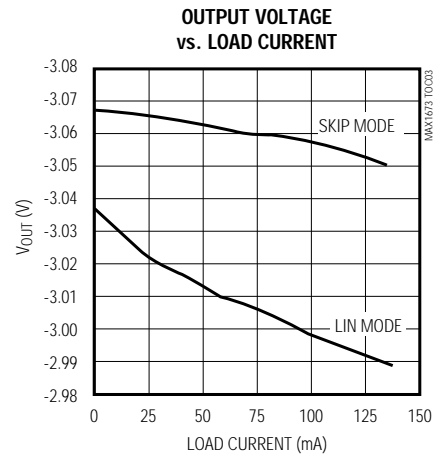
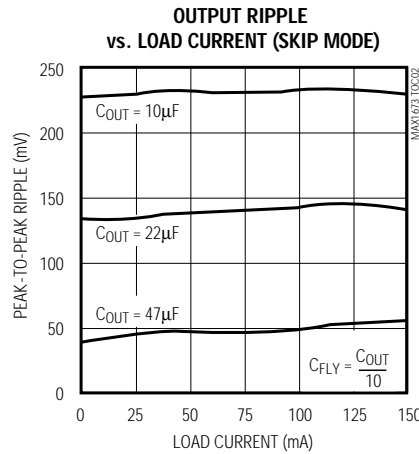
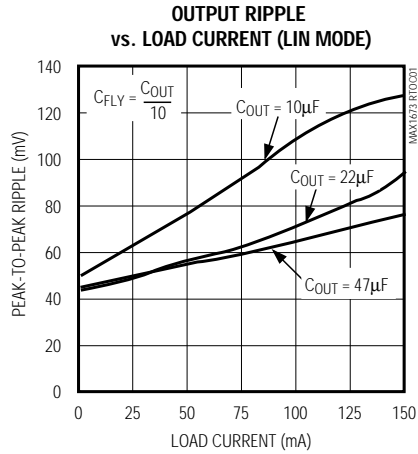
PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Switching Frequency (LIN Mode)	f_{OSC}	$T_A = +25^{\circ}C$		250	350	460	kHz
		$T_A = -40^{\circ}C$ to $+85^{\circ}C$		205		515	
FB Threshold	V_{FBT}	LIN/SKIP = GND (Skip mode)		-25	0	25	mV
FB Input Bias Current	I_{FB}	LIN/SKIP = IN (LIN mode)	$V_{FB} = -25mV$		150	600	nA
		LIN/SKIP = GND (Skip mode)			1	100	
Input Bias Current (SHDN, LIN/SKIP)						1	μA
Logic High Input (SHDN, LIN/SKIP)	V_{IH}	$2V \leq V_{IN} \leq 5.5V$		$0.7 \times V_{IN}$			V
Logic Low Input (SHDN, LIN/SKIP)	V_{IL}	$2V \leq V_{IN} \leq 5.5V$		$0.3 \times V_{IN}$			V

Note 2: Specifications to $-40^\circ C$ are guaranteed by design, not production tested.

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Typical Operating Characteristics

(Circuit of Figure 1, $V_{IN} = +5V$, $C_{FLY} = 2.2\mu F$, $C_{OUT} = 22\mu F$, $T_A = +25^\circ C$, unless otherwise noted.)

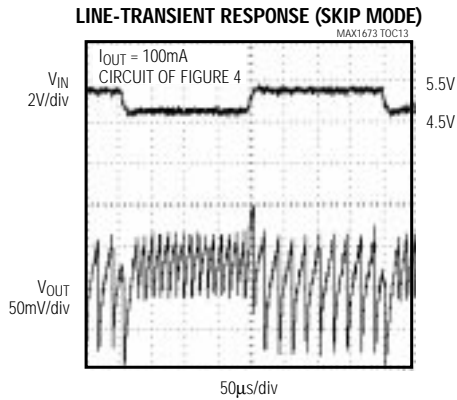
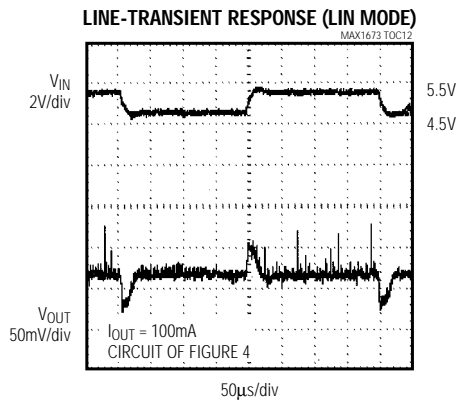
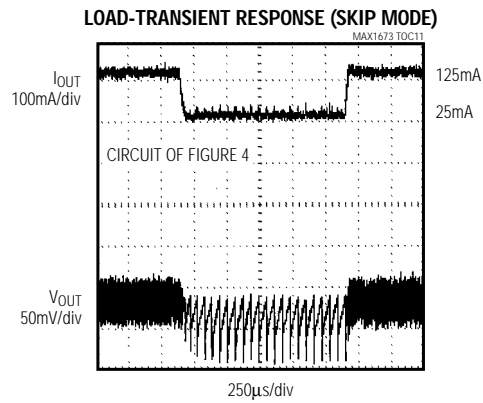
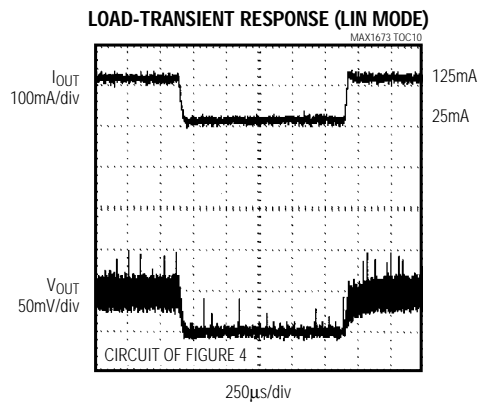


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Typical Operating Characteristics (continued)

(Circuit of Figure 1, $V_{IN} = +5V$, $C_{FLY} = 2.2\mu F$, $C_{OUT} = 22\mu F$, $T_A = +25^\circ C$, unless otherwise noted.)

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Pin Description

PIN	NAME	FUNCTION
1	LIN/SKIP	Regulation-Mode Select Input. Driving LIN/SKIP high or connecting it to IN selects LIN mode, with regulation accomplished by modulating switch resistance. Driving LIN/SKIP low or connecting it to GND selects Skip mode, where the device regulates by skipping charge-pump pulses.
2	CAP+	Positive Terminal of Flying Capacitor
3	CAP-	Negative Terminal of Flying Capacitor
4	SHDN	Shutdown Control Input. Drive SHDN low to shut down the MAX1673. Connect SHDN to IN for normal operation. OUT connects to GND through a 1Ω (typical) resistor in shutdown mode.
5	OUT	Inverting Charge-Pump Output
6	FB	Feedback Input. Connect FB to a resistor-divider from IN (or other reference source) to OUT for regulated output voltages (Figures 1 and 4).
7	GND	Ground
8	IN	Power-Supply Positive Voltage Input

Detailed Description

The MAX1673 new-generation, high-output-current, regulated charge-pump DC-DC inverter provides up to 125mA. Designed specifically for compact applications, a complete regulating circuit requires only three small capacitors and two resistors. The MAX1673 employs On-Demand™ regulation circuitry, providing output regulation modes optimized for either lowest output noise or lowest supply current. In addition, the MAX1673 includes shutdown control.

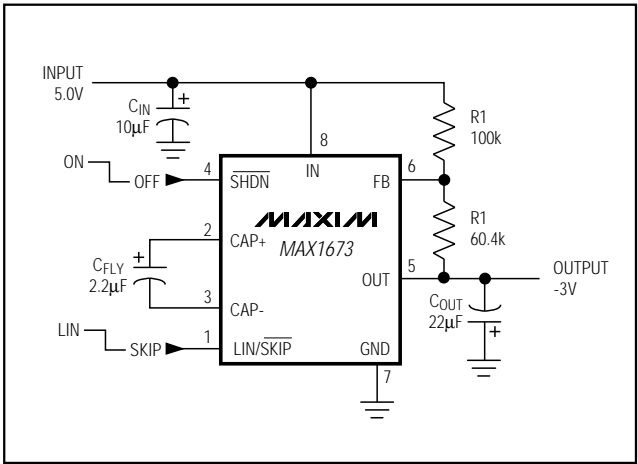


Figure 1. Standard Application Circuit

In Linear (LIN) mode or when heavily loaded in Skip mode, the charge pump runs continuously at 350kHz. During one-half of the oscillator period, switches S1 and S2 close (Figure 2), charging the transfer capacitor (CFLY) to the input voltage (CAP- = GND, and CAP+ = IN). During the other half cycle, switches S3 and S4 close (Figure 3), transferring the charge on CFLY to the output capacitor (CAP+ = GND, CAP- = OUT).

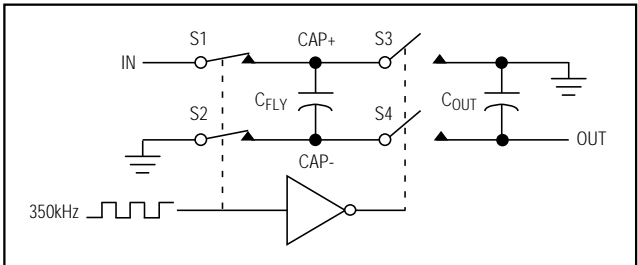


Figure 2. Charging CFLY

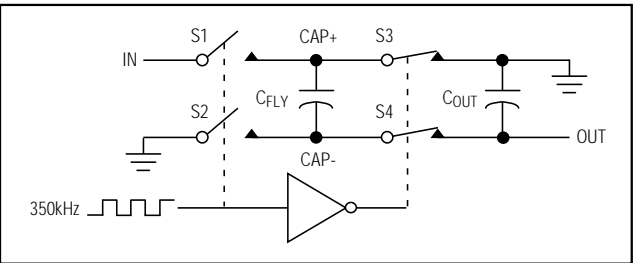


Figure 3. Transferring Charge on CFLY to COUT

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Linear Mode (Constant-Frequency Mode)

In LIN mode ($\overline{\text{LIN/SKIP}} = \text{IN}$), the charge pump runs continuously at 350kHz. The MAX1673 controls the charge on C_{FLY} by varying the gate drive on S1 (Figure 2). When the output voltage falls, C_{FLY} charges faster due to increased gate drive. Since the device switches continuously, the regulation scheme minimizes output ripple, the output noise contains well-defined frequency components, and the circuit requires much smaller external capacitors than in Skip mode for a given output ripple.* However, LIN mode is less efficient than Skip mode due to higher operating current (8mA typical).

Skip Mode

In Skip mode ($\overline{\text{LIN/SKIP}} = \text{GND}$), the device switches only as needed to maintain regulation on FB. Switching cycles are skipped until the voltage on FB rises above GND. Skip mode has higher output noise than LIN mode, but minimizes operating current.

Shutdown Mode

When $\overline{\text{SHDN}}$ (a CMOS-compatible input) is driven low, the MAX1673 enters low-power shutdown mode. Charge-pump switching action halts and an internal 1Ω switch pulls V_{OUT} to ground. Connect $\overline{\text{SHDN}}$ to IN or drive high for normal operation.

*See Output Ripple vs. Load Current in *Typical Operating Characteristics*.

Applications Information

Resistor Selection (Output Voltage Selection)

The accuracy of V_{OUT} depends on the accuracy of the voltage biasing the voltage-divider network ($R1$, $R2$). Use a separate reference voltage if V_{IN} is an unregulated voltage or if greater accuracy is desired (Figure 4).

Adjust the output voltage from -1.5V to $-V_{\text{IN}}$ in LIN mode or 0V to $-V_{\text{IN}}$ in Skip mode with external resistors $R1$ and $R2$ as shown in Figures 1 and 4. In either regulating mode (LIN or Skip), FB servos to 0V . Use the following equations to select $R1$ and $R2$ for the desired output voltage:

$$V_{\text{OUT}} = -V_{\text{REF}} \frac{R2}{R1}$$

where V_{REF} can be either V_{IN} or some other positive reference source.

Typically, choose a voltage-divider current of $50\mu\text{A}$ to minimize the effect of FB input current:

$$R1 = V_{\text{REF}} / 50\mu\text{A}$$

$$R2 = -V_{\text{OUT}} / 50\mu\text{A}$$

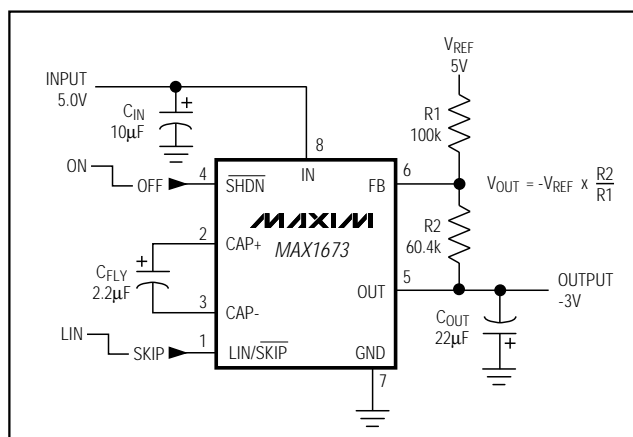


Figure 4. Separate V_{REF} for Voltage Divider

Capacitor Selection

A C_{FLY} value of $1\mu\text{F}$ or more is sufficient to supply the specified load current. However, for minimum ripple in Skip mode, this value may need to be increased. Maxim recommends $2.2\mu\text{F}$.

Surface-mount ceramic capacitors are preferred for C_{FLY} , due to their small size, low cost, and low equivalent series resistance (ESR). To ensure proper operation over the entire temperature range, choose ceramic capacitors with X7R (or equivalent) low-temperature-coefficient (tempco) dielectrics. See Table 1 for a list of suggested capacitor suppliers.

The output capacitor stores the charge transferred from the flying capacitor and services the load between oscillator cycles. A good general rule is to make the output capacitance at least ten times greater than that of the flying capacitor.

When in Skip mode, output ripple depends mostly on two parameters: charge transfer between the capacitance values of C_{FLY} and C_{OUT} , and the ESR of C_{OUT} . The ESR ripple contribution occurs as C_{OUT} charges. The charging current creates a negative voltage pulse across the capacitor's ESR that recedes as C_{OUT} charges. At equilibrium, when the voltage on C_{FLY} approaches that on C_{OUT} , no charging current flows. Secondly, the ripple contribution due to charge transfer between capacitors creates a pulse as charge flows to C_{OUT} . Adding the two terms does not determine peak-to-peak ripple because their peaks do not occur at the same time. It is best to use only the dominant term. The expression for the ripple component predominantly due to C_{OUT} ESR is:

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$$V_{\text{RIPPLE(ESR)}} = 8 \left(\frac{V_{\text{IN}} - |V_{\text{OUT}}|}{f_{\text{OSC}}} \right) \left(\frac{\text{ESR}_{\text{COUT}}}{R_{\text{OUT}}^2 C_{\text{FLY}}} \right)$$

The expression for the ripple component predominantly due to charge transfer is:

$$V_{\text{RIPPLE(ESR)}} = 2 \left(\frac{V_{\text{IN}} - |V_{\text{OUT}}|}{f_{\text{OSC}}} \right) \left(\frac{1}{R_{\text{OUT}} (C_{\text{FLY}} + C_{\text{OUT}})} \right)$$

where C_{FLY} and C_{OUT} are their respective capacitance values, ESR_{COUT} is the equivalent series resistance of C_{OUT} , R_{OUT} is the MAX1673 open-loop output impedance (typically 3.5Ω), and f_{OSC} is the MAX1673 switching frequency (typically 350kHz). If ESR_{COUT} is very small, as is likely when ceramic capacitors are used, $V_{\text{RIPPLE(TRANSFER)}}$ dominates. If ESR is relatively large, as with low-cost tantalum capacitors, then $V_{\text{RIPPLE(ESR)}}$ dominates.

When operating in LIN mode, use the following equation to approximate peak-to-peak output voltage ripple:

$$V_{\text{RIPPLE}} = \frac{I_{\text{OUT}}}{2 f_{\text{OSC}} C_{\text{OUT}}} + 2 I_{\text{OUT}} \text{ESR}_{\text{COUT}}$$

where C_{OUT} is the output capacitor value, ESR_{COUT} is the output capacitor's ESR, and f_{OSC} is the MAX1673 oscillator frequency (typically 350kHz).

To ensure LIN mode stability over the entire temperature range, choose a low-ESR (no more than $100\text{m}\Omega$) output capacitance using the following equation:

$$C_{\text{OUT}} = 75 \times 10^{-6} \left(\frac{R_1}{R_1 + R_2} \right) \sqrt{I_{\text{OUT}}}$$

where C_{OUT} is the output capacitor value, and f_{MIN} is the minimum oscillator frequency (250kHz). See Table 1 for a list of suggested capacitor suppliers.

Layout Considerations

The MAX1673's high oscillator frequency requires good layout technique, which ensures stability and helps maintain the output voltage under heavy loads. Take the following steps to ensure good layout:

- Mount all components as close together as possible.
- Place the feedback resistors R_1 and R_2 close to the FB pin, and minimize the PC trace length at the FB circuit node.
- Keep traces short to minimize parasitic inductance and capacitance.
- Use a ground plane.

Chip Information

TRANSISTOR COUNT: 386

SUBSTRATE CONNECTED TO: IN

Table 1. Partial Listing of Capacitor Vendors

PRODUCTION METHOD	MANUFACTURER	SERIES	PHONE	FAX
Surface-Mount Tantalum	AVX	TPS	(803) 946-0690	(803) 448-2170
	Matsuo	267	(714) 969-2491	(714) 960-6492
	Sprague	593D, 595D	(603) 224-1961	(603) 224-1430
Surface-Mount Ceramic	AVX	X7R	(803) 946-0590	(803) 626-3123
	Matsuo	X7R	(714) 969-2491	(714) 960-6492

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